

# SILICON PLANAR EPITAXIAL TRANSISTORS

PNP transistors in miniature plastic packages intended for use in amplifier and switching applications. Complementary types are RSP19/20.

## QUICK REFERENCE DATA

		BSP15	BSP16
Collector-base voltage (open emitter)	-V <sub>CBO</sub>	max.	200
Collector-emitter voltage (open base)	-V <sub>CEO</sub>	max.	200
Collector current (DC)	-I <sub>C</sub>	max.	1
Total power dissipation up to T <sub>amb</sub> = 25 °C	P <sub>tot</sub>	max.	1,5
Junction temperature	T <sub>J</sub>	max.	150
DC current gain -V <sub>CE</sub> = 10 V; -I <sub>C</sub> = 50 mA	h <sub>FE</sub>	30 to 150	30 to 120
Transition frequency -V <sub>CE</sub> = 10 V; -I <sub>C</sub> = 10 mA	f <sub>T</sub>	>	15
			MHz

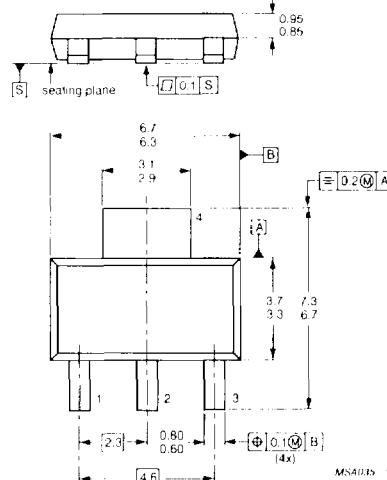
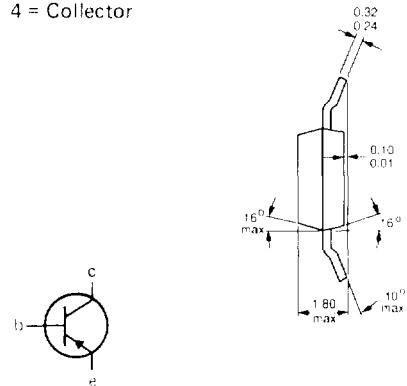
## MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-223

## Pinning

- 1 = Base  
2 = Collector  
3 = Emitter  
4 = Collector



**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

		BSP15	BSP16
Collector-base voltage (open emitter)	-V <sub>CBO</sub>	max. 200	350 V
Collector-emitter voltage (open base)	-V <sub>CEO</sub>	max. 200	300 V
Emitter-base voltage (open collector)	-V <sub>EBO</sub>	max. 4	6 V
Collector current (DC)	-I <sub>C</sub>	max. 1	A
Base current	I <sub>B</sub>	max. 0,5	A
Total power dissipation up to T <sub>amb</sub> = 25 °C*	P <sub>tot</sub>	max. 1,5	W
Junction temperature	T <sub>j</sub>	max. 150	°C
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C

**THERMAL RESISTANCE**from junction to ambient\* R<sub>th j mb</sub> = 83,3 K/W**CHARACTERISTICS**T<sub>j</sub> = 25 °C unless otherwise specified

		BSP15	BSP16
Collector cut-off current			
I <sub>E</sub> = 0; -V <sub>CB</sub> = 175 V	-I <sub>CBO</sub>	< 1	- μA
I <sub>E</sub> = 0; -V <sub>CB</sub> = 280 V	-I <sub>CBO</sub>	< -	1 μA
I <sub>B</sub> = 0; -V <sub>CE</sub> = 150 V	-I <sub>CEO</sub>	< 50	- μA
I <sub>B</sub> = 0; -V <sub>CE</sub> = 250 V	-I <sub>CEO</sub>	< -	50 μA
Emitter cut-off current			
I <sub>C</sub> = 0; -V <sub>EB</sub> = 4 V	-I <sub>EBO</sub>	< 20	- μA
I <sub>C</sub> = 0; -V <sub>EB</sub> = 6 V	-I <sub>EBO</sub>	< -	20 μA
Collector-emitter breakdown voltage			
I <sub>B</sub> = 0; -I <sub>C</sub> = 50 mA; L = 25 mH	-V <sub>(BR)CEO</sub>	> 200	300 V
Collector-emitter saturation voltage			
-I <sub>C</sub> = 50 mA; -I <sub>B</sub> = 5 mA	-V <sub>CESat</sub>	< 2,5	2,0 V
DC current gain			
-V <sub>CE</sub> = 10 V; -I <sub>C</sub> = 50 mA	h <sub>FE</sub>	30 to 150	30 to 120
Transition frequency at f = 30 MHz	f <sub>T</sub>	> 15	MHz
-I <sub>C</sub> = 10 mA; -V <sub>CE</sub> = 10 V			
Collector capacitance at f = 1 MHz	C <sub>c</sub>	< 15	pF
I <sub>E</sub> = I <sub>e</sub> = 0; -V <sub>CB</sub> = 10 V			

Device mounted on an epoxy printed circuit board 40 mm x 40 mm x 1,5 mm;  
mounting pad for the collector lead min. 6 cm<sup>2</sup>.